



# Additive Manufacturing Science Lab

## [Niino Laboratory]

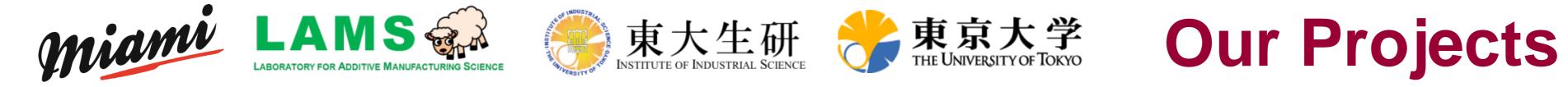
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### **3D Printing and MID (Molded Interconnect Device)**

**Functional Geometrically-shaped Parts Manufacturing Technologies: Additive Manufacturing Technology and Molded Interconnect Devices** This lab aims to create newly functional device of mechanical and electrical combined as one. To do this, we emphasize on functional 3D geometrical shape made of combined material. In detail, we focus on Additive Manufacutring (AM) and Molded Interconnect Device (MID) and their application.



### **Additive Manufacturing** Study on fabrication process

- **Process Development in Laser Sintering Fabrication**
- Laser Sintering process development for Super Engineering **Plastics**



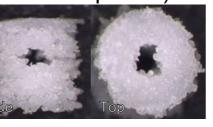
- Laser Sintering Fabrication realizing High Porosity and Intensity



Preheat-free process



Eiffel tower using PEEK (High heat resistance plastic)



Microscopic object fabrication

• Laser Sintering Fabrication of Tissue Engineering Scaffolds

#### **MID** Molded Interconnect Device MEMS on MID Chip on MID Laser diode MEMS Scanner Aligned by MID / CCD , Processor Built-up laminate sheet PCB on MID Connected by MID Half mirror Aspheric Lens Heat-resistant Transparent Plastic casing

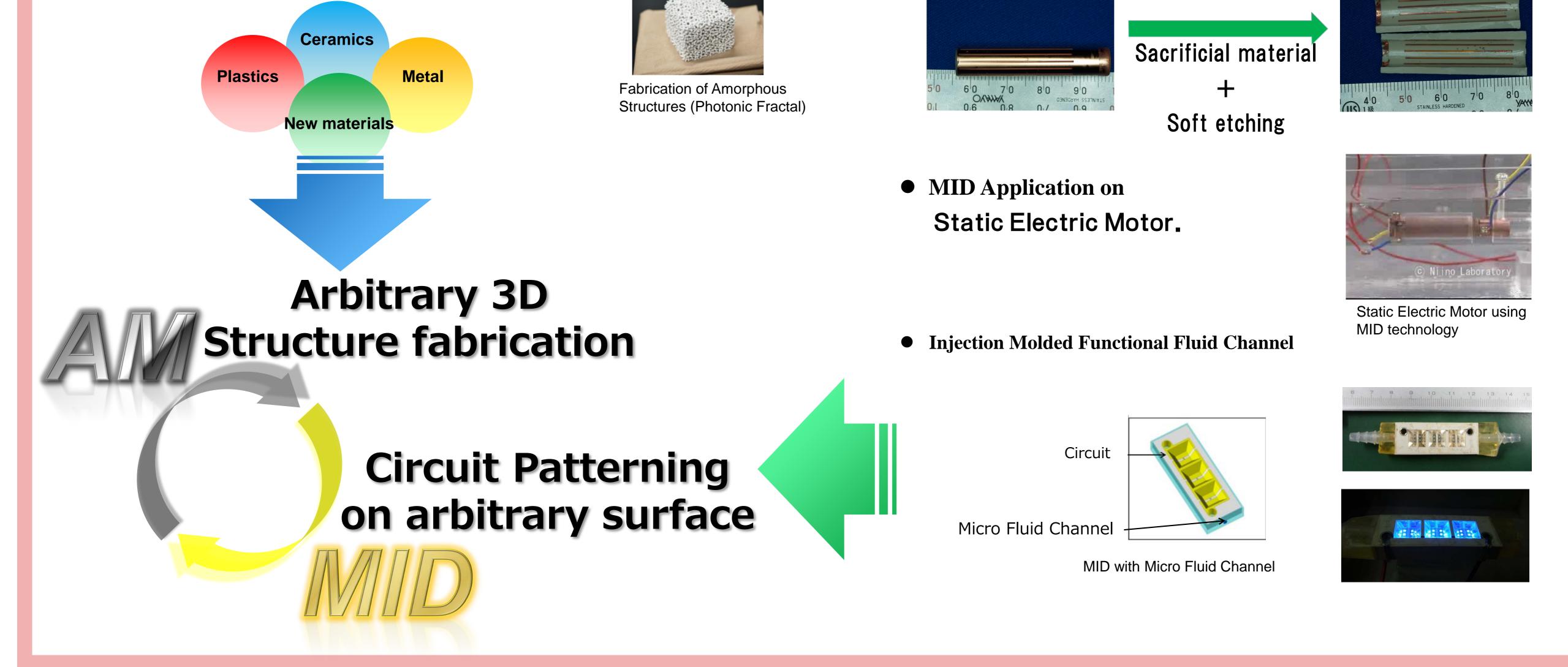
**Study on fabrication process of MIDs** MID fabrication process using sacrificial material

**MID** Application on Mechatronic Devices



CT scan of Scaffolds showing minute flow channels

**Application of Photonic Device using Laser Sintering Fabrication** 





Circuit pattern transfer to inner surface using sacrificial material.

#### Study on MID application

Circuit pattern transfer to inner surface of objects using sacrificial material





